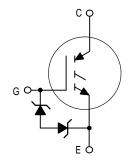
Designer's™ Data Sheet

Insulated Gate Bipolar TransistorN-Channel Enhancement-Mode Silicon Gate

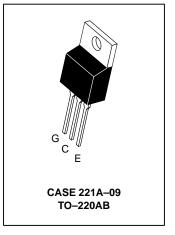
This Insulated Gate Bipolar Transistor (IGBT) uses an advanced termination scheme to provide an enhanced and reliable high voltage–blocking capability. Its new 600 V IGBT technology is specifically suited for applications requiring both a high temperature short circuit capability and a low VCE(on). It also provides fast switching characteristics and results in efficient operation at high frequencies. This new E–series introduces an energy efficient, ESD protected, and short circuit rugged device.

- Industry Standard TO-220 Package
- High Speed: E_{off} = 60 μJ/A typical at 125°C
- High Voltage Short Circuit Capability 10 μs minimum at 125°C, 400 V
- Low On-Voltage 2.0 V typical at 5.0 A, 125°C
- Robust High Voltage Termination
- ESD Protection Gate-Emitter Zener Diodes



MGP7N60E

IGBT IN TO-220
9.0 A @ 90°C
10 A @ 25°C
600 VOLTS
SHORT CIRCUIT RATED
LOW ON-VOLTAGE



MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit	
Collector–Emitter Voltage	VCES	600	Vdc	
Collector–Gate Voltage ($R_{GE} = 1.0 \text{ M}\Omega$)	VCGR	600	Vdc	
Gate-Emitter Voltage — Continuous	VGE	±20	Vdc	
Collector Current — Continuous @ T _C = 25°C — Continuous @ T _C = 90°C — Repetitive Pulsed Current (1)	I _{C25} I _{C90} I _{CM}	10 7.0 14	Adc Apk	
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	81 0.65	Watts W/°C	
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to 150	°C	
Short Circuit Withstand Time $(V_{CC} = 400 \text{ Vdc}, V_{GE} = 15 \text{ Vdc}, T_J = 125^{\circ}C, R_G = 20 \Omega)$	t _{SC}	10	μs	
Thermal Resistance — Junction to Case – IGBT — Junction to Ambient	R _θ JC R _θ JA	1.5 65	°C/W	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C	
Mounting Torque, 6–32 or M3 screw	10 lbf•in (1.13 N•m)			

⁽¹⁾ Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

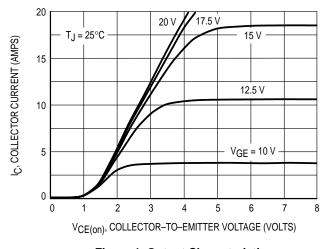
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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Cha	racteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		•		•		
Collector–to–Emitter Breakdown Vo (V _{GE} = 0 Vdc, I _C = 25 μAdc) Temperature Coefficient (Positive		V(BR)CES	600 —	 870	_	Vdc mV/°C
Emitter-to-Collector Breakdown Voltage (V _{GE} = 0 Vdc, I _{EC} = 100 mAdc)		V(BR)ECS	15	_	_	Vdc
Zero Gate Voltage Collector Curren (V _{CE} = 600 Vdc, V _{GE} = 0 Vdc) (V _{CE} = 600 Vdc, V _{GE} = 0 Vdc, T		ICES		_	10 200	μAdc
Gate-Body Leakage Current (VGE = ± 20 Vdc, VCE = 0 Vdc)		IGES	_	_	50	μAdc
ON CHARACTERISTICS (1)		•		•	•	
	= 125°C)	VCE(on)	_ _ _	1.6 1.5 2.0	1.9 — 2.4	Vdc
Gate Threshold Voltage (V _{CE} = V _{GE} , I _C = 1.0 mAdc) Threshold Temperature Coefficien	nt (Negative)	VGE(th)	4.0 —	6.0 10	8.0 —	Vdc mV/°C
Forward Transconductance (V _{CE} =	10 Vdc, I _C = 5.0 Adc)	9fe	_	2.5	_	Mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance	(V _{CE} = 25 Vdc, V _{GE} = 0 Vdc, f = 1.0 MHz)	C _{ies}		610	_	pF
Output Capacitance		C _{oes}	ĺ	60	_	
Transfer Capacitance		C _{res}		10	_	
SWITCHING CHARACTERISTICS (1	1)					
Turn-On Delay Time		^t d(on)	_	22	_	ns
Rise Time	$(V_{CC}=360~Vdc,~I_{C}=5.0~Adc,~V_{GE}=15~Vdc,~L=300~\mu H,~R_{G}=20~\Omega,~T_{J}=25^{\circ}C)$ Energy losses include "tail"	t _r	_	24	_	
Turn-Off Delay Time		^t d(off)		64	_	
Fall Time		t _f		196	_	
Turn-Off Switching Loss		E _{off}	_	0.20	0.34	mJ
Turn-On Delay Time	(V _{CC} = 360 Vdc, I _C = 5.0 Adc, V _{GE} = 15 Vdc, L = 300 μH, R _G = 20 Ω, T _J = 125°C) Energy losses include "tail"	t _d (on)	_	31	_	ns
Rise Time		t _r	_	24	_	
Turn-Off Delay Time		td(off)	_	195	_	
Fall Time		t _f	_	220	_	
Turn-Off Switching Loss		E _{off}	_	0.38	_	mJ
Gate Charge	(V _{CC} = 360 Vdc, I _C = 5.0 Adc, V _{GE} = 15 Vdc)	QT	_	27.2	_	nC
		Q ₁	_	7.0	_	1
		Q ₂	_	13.7	_]
NTERNAL PACKAGE INDUCTANC	E					
Internal Emitter Inductance (Measured from the emitter lead	0.25" from package to emitter bond pad)	LE	_	7.5	_	nH

⁽¹⁾ Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.





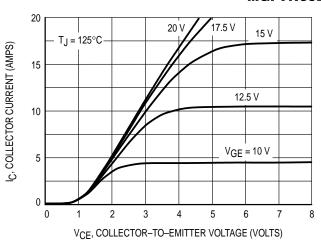


Figure 2. Output Characteristics

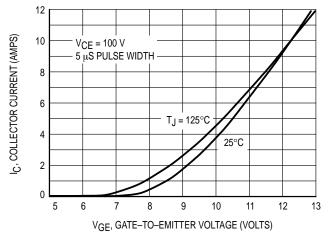


Figure 3. Transfer Characteristics

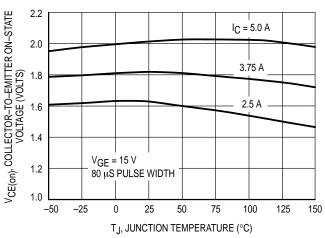


Figure 4. VCE versus Junction Temperature

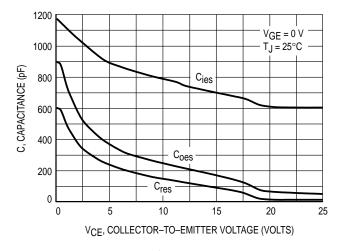


Figure 5. Capacitance Variation

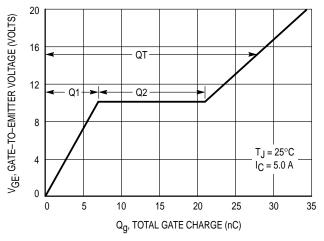


Figure 6. VGE versus Total Charge

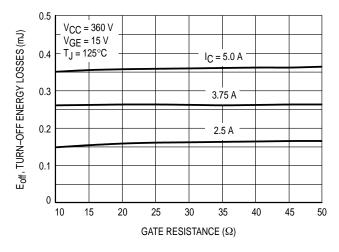


Figure 7. Turn-Off Losses versus Gate Resistance

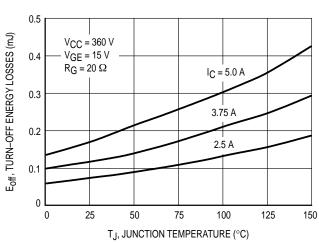


Figure 8. Turn-Off Losses versus Junction Temperature

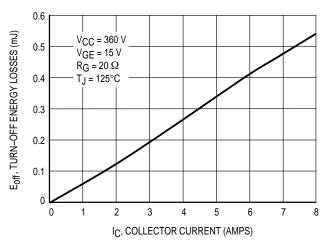


Figure 9. Turn-Off Energy Losses versus Collector Current

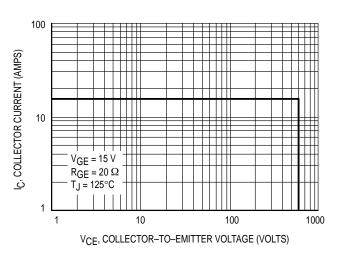
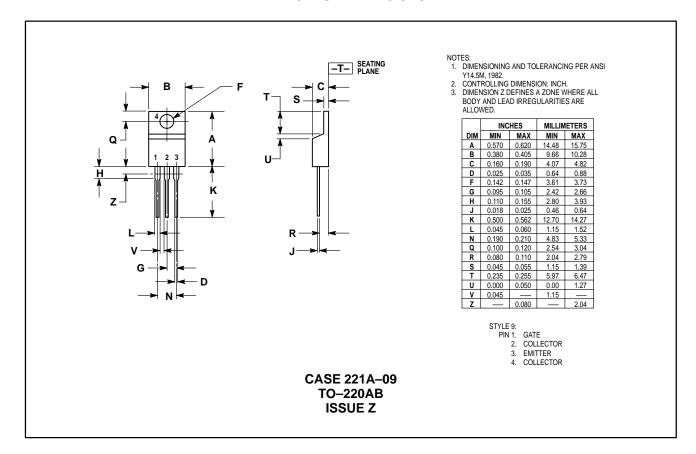


Figure 10. Reverse Biased Safe Operating Area

PACKAGE DIMENSIONS



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